

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT																
NATURE OF CONVEYANCE:	ASSIGNMENT																
CONVEYING PARTY DATA																	
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Eiji Ohta</td><td>08/25/2008</td></tr><tr><td>Ken Hosoya</td><td>08/26/2008</td></tr><tr><td>Yasuyuki Kudo</td><td>08/26/2008</td></tr><tr><td>Shigehiro Yamakita</td><td>08/26/2008</td></tr><tr><td>Masayasu Kakinuma</td><td>08/26/2008</td></tr><tr><td>Taku Ishimori</td><td>08/29/2008</td></tr><tr><td>Shogo Shinkai</td><td>08/26/2008</td></tr></tbody></table>	Name	Execution Date	Eiji Ohta	08/25/2008	Ken Hosoya	08/26/2008	Yasuyuki Kudo	08/26/2008	Shigehiro Yamakita	08/26/2008	Masayasu Kakinuma	08/26/2008	Taku Ishimori	08/29/2008	Shogo Shinkai	08/26/2008	
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RECEIVING PARTY DATA																	
Name:	Sony Corporation																
Street Address:	1-7-1 Konan, Minato-ku																
City:	Tokyo																
State/Country:	JAPAN																
PROPERTY NUMBERS Total: 1																	
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>12212194</td></tr></tbody></table>	Property Type	Number	Application Number:	12212194													
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CORRESPONDENCE DATA																	
Fax Number:	(312)827-8185																
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>																	
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ATTORNEY DOCKET NUMBER:	112857-1403																
NAME OF SUBMITTER:	Thomas C. Basso																

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PATENT
REEL: 021579 FRAME: 0858

Total Attachments: 3

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PATENT

REEL: 021579 FRAME: 0859

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in OPTICAL ELEMENT COVERING MEMBER, BACKLIGHT, AND LIQUID CRYSTAL DISPLAY DEVICE

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 1-7-1 Konan, Minato-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 12/121,194, Filing Date: 09/17/2008.

This assignment executed on the dates indicated below.

Eiji OHTA

Name of first or sole inventor

Execution date of U.S. Patent Application

Miyagi, Japan

Residence of first or sole inventor

Eiji Ohta

August 25, 2008

Signature of first or sole inventor

Date of this assignment

Ken HOSOYA

Name of second inventor

Execution date of U.S. Patent Application

Miyagi, Japan

Residence of second inventor

Ken Hosoya
Signature of second inventor*August 26, 2008*
Date of this assignment

Yasuyuki KUDO

Name of third inventor

Execution date of U.S. Patent Application

Miyagi, Japan

Residence of third inventor

Yasuyuki Kudo
Signature of third inventor*August 26, 2008*
Date of this assignment

Shigehiro YAMAKITA

Name of fourth inventor

Execution date of U.S. Patent Application

Miyagi, Japan

Residence of fourth inventor

Shigehiro Yamakita
Signature of fourth inventor*August 26, 2008*
Date of this assignment

Masayasu KAKINUMA

Name of fifth inventor

Execution date of U.S. Patent Application

Miyagi, Japan

Residence of fifth inventor

Masayasu Kakinuma
Signature of fifth inventor*August 26, 2008*
Date of this assignment

Taku ISHIMORI

Name of sixth inventor

Execution date of U.S. Patent Application

Miyagi, Japan

Residence of sixth inventor

*Taku Ishimori**August 29, 2008*

Signature of sixth inventor

Date of this assignment

Shogo SHINKAI

Name of seventh inventor

Execution date of U.S. Patent Application

Miyagi, Japan

Residence of seventh inventor

*Shogo Shinkai**August 26, 2008*

Signature of seventh inventor

Date of this assignment

Name of eighth inventor

Execution date of U.S. Patent Application

Residence of eighth inventor

Signature of eighth inventor

Date of this assignment

Name of ninth inventor

Execution date of U.S. Patent Application

Residence of ninth inventor

Signature of ninth inventor

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